SABIC® PC RESIN PC0800

REGION AMERICAS

DESCRIPTION

PC0800 resin is a low flow (MFR = 8 at 300?C/1.2kg), heat stabilized, polycarbonate product designed for use in the custom compounding market. It does not contain UV stabilizer or mold release.

TYPICAL PROPERTY VALUES

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL			
Tensile Stress, yld, Type I, 50 mm/min	63	MPa	ASTM D638
Tensile Strain, yld, Type I, 50 mm/min	6	%	ASTM D638
Tensile Strain, brk, Type I, 50 mm/min	>70	%	ASTM D638
Tensile Modulus, 50 mm/min	2350	MPa	ASTM D638
Flexural Stress, yld, 1.3 mm/min, 50 mm span	90	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	2300	MPa	ASTM D790
Hardness, Rockwell R	120	-	ASTM D785
Tensile Stress, yield, 50 mm/min	63	MPa	ISO 527
Tensile Strain, yield, 50 mm/min	6	%	ISO 527
Tensile Strain, break, 50 mm/min	>70	%	ISO 527
Tensile Modulus, 1 mm/min	2350	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	90	MPa	ISO 178
Flexural Modulus, 2 mm/min	2300	MPa	ISO 178
Hardness, Rockwell R	120	-	ISO 2039-2
IMPACT			
Izod Impact, unnotched, 23°C	NB	J/m	ASTM D4812
Izod Impact, notched, 23°C	900	J/m	ASTM D256
Instrumented Dart Impact Energy @ peak, 23°C	65	J	ASTM D3763
Izod Impact, unnotched 80*10*3 +23°C	NB	kJ/m²	ISO 180/1U
Izod Impact, unnotched 80*10*3 -30°C	NB	kJ/m²	ISO 180/1U
Izod Impact, notched 80*10*3 +23°C	70	kJ/m²	ISO 180/1A
Izod Impact, notched 80*10*3 -30°C	12	kJ/m²	ISO 180/1A
THERMAL			
Vicat Softening Temp, Rate B/50	144	°C	ASTM D1525
HDT, 0.45 MPa, 3.2 mm	138	°C	ASTM D648
HDT, 1.82 MPa, 3.2 mm	127	°C	ASTM D648
CTE, -40°C to 95°C, flow	7.E-05	1/°C	ASTM E831
Thermal Conductivity	0.2	W/m-°C	ASTM C177
Thermal Conductivity	0.2	W/m-°C	ISO 8302
CTE, 23°C to 80°C, flow	7.E-05	1/°C	ISO 11359-2
Ball Pressure Test, 125°C +/- 2°C	Passes	-	IEC 60695-10-2
Vicat Softening Temp, Rate B/50	144	°C	ISO 306
HDT/Bf, 0.45 MPa Flatw 80*10*4 sp=64mm	138	°C	ISO 75/Bf
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	127	°C	ISO 75/Af

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PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
PHYSICAL			
Specific Gravity	1.2	-	ASTM D792
Water Absorption, (23°C/Saturated)	0.35	%	ASTM D570
Mold Shrinkage on Tensile Bar, flow	0.5 – 0.7	%	SABIC method
Mold Shrinkage, flow, 3.2 mm	0.5 – 0.7	%	SABIC method
Melt Flow Rate, 300°C/1.2 kgf	8	g/10 min	ASTM D1238
Density	1.2	g/cm³	ISO 1183
Water Absorption, (23°C/saturated)	0.35	%	ISO 62-1
Melt Volume Rate, MVR at 300°C/1.2 kg	7	cm³/10 min	ISO 1133
OPTICAL			
Light Transmission, 2.54 mm	88 – 90	%	ASTM D1003
Haze, 2.54 mm	<0.8	%	ASTM D1003
Refractive Index	1.586	-	ASTM D542
Refractive Index	1.586	-	ISO 489
ELECTRICAL			
Volume Resistivity	>1.E+15	Ω.cm	ASTM D257
Dielectric Strength, 1.6 mm	27	kV/mm	ASTM D149
Relative Permittivity, 60 Hz	3	-	ASTM D150
Relative Permittivity, 1 MHz	3	-	ASTM D150
Dissipation Factor, 60 Hz	0.001	-	ASTM D150
Dissipation Factor, 1 MHz	0.01	-	ASTM D150
Volume Resistivity	>1.E+15	Ω.cm	IEC 60093
Dielectric Strength, 1.6 mm	27	kV/mm	IEC 60243-1
Relative Permittivity, 60 Hz	3	-	IEC 60250
Relative Permittivity, 1 MHz	3	-	IEC 60250
Dissipation Factor, 60 Hz	0.001	-	IEC 60250
Dissipation Factor, 1 MHz	0.01	-	IEC 60250
INJECTION MOLDING			
Drying Temperature	120	°C	
Drying Time	2 – 4	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	290 – 320	°C	
Nozzle Temperature	280 – 310	°C	
Front - Zone 3 Temperature	290 – 320	°C	
Middle - Zone 2 Temperature	280 – 310	°C	
Rear - Zone 1 Temperature	270 – 300	°C	
Hopper Temperature	60 – 80	°C	
Mold Temperature	80 – 120	°C	